

**600mA LOW DROPOUT LINEAR REGULATOR****AP2316****General Description**

The AP2316 is a series of low dropout three-terminal regulators with a dropout of 1.1V at 600mA output current.

This product has been optimized for low voltage where transient response and minimum input voltage are critical. The AP2316 provides current limit and thermal shutdown. Its circuit includes a trimmed bandgap reference to assure output voltage accuracy to be within  $\pm 1\%$ . On-chip thermal shutdown provides protection against any combination of overload and ambient temperatures that would create excessive junction temperatures.

The AP2316 is available in 2.5V and 3.3V versions. The fixed versions integrate the corresponding resistor divider.

The AP2316 is available in the industry standard SOT-89-3 power package.

**Features**

- Low Dropout Voltage: 1.1V at 600mA Output Current
- Output Noise from 10Hz to 10KHz: 0.003% of  $V_{OUT}$
- PSRR at  $I_{OUT}=300mA$  and  $f=120Hz$ : 75dB
- Output Voltage Accuracy:  $\pm 1\%$
- On-chip Thermal Shutdown
- Maximum Quiescent Current:  $I_{QMAX}=5mA$
- ESD (Human Body Model): 3.5KV
- Operation Junction Temperature: -40 to 125°C

**Applications**

- DVD/CD-ROM
- USB Device
- Add-on Card
- DVD Player
- PC Motherboard

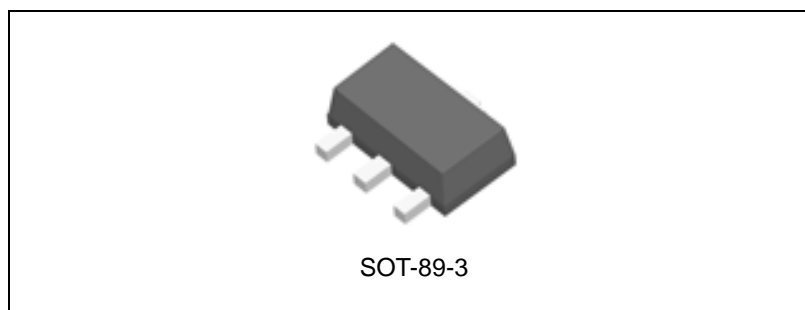


Figure 1. Package Type of AP2316



**600mA LOW DROPOUT LINEAR REGULATOR**

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**Pin Configuration**

R Package  
(SOT-89-3)

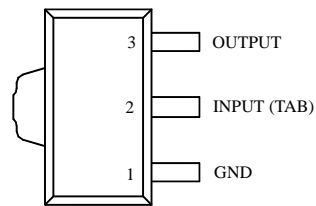


Figure 2. Pin Configuration of AP2316 (Top View)



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**Functional Block Diagram**

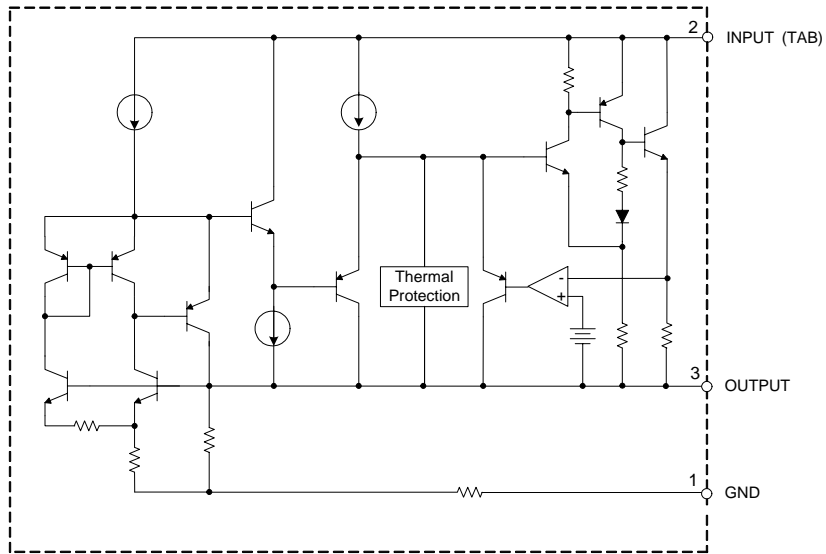
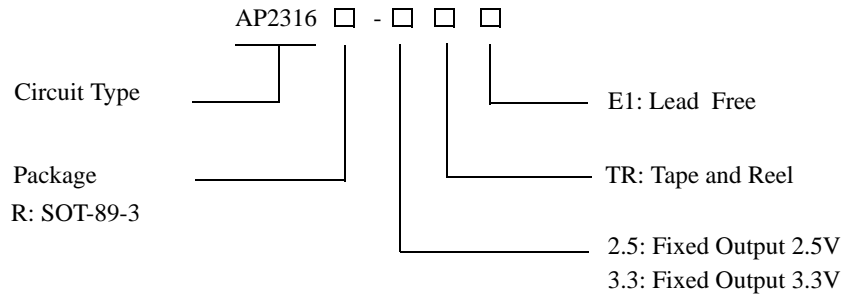


Figure 3. Functional Block Diagram of AP2316



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**Ordering Information**



Package	Temperature Range	Part Number	Marking ID	Packing Type
SOT-89-3	-40 to 125°C	AP2316R-2.5TRE1	E27H	Tape & Reel
		AP2316R-3.3TRE1	E27J	Tape & Reel

BCD Semiconductor's Pb-free products, as designated with "E1" suffix in the part number, are RoHS compliant.

**600mA LOW DROPOUT LINEAR REGULATOR****AP2316****Absolute Maximum Ratings (Note 1)**

Parameter	Symbol	Value	Unit
Input Voltage	$V_{IN}$	15	V
Operating Junction Temperature	$T_J$	150	°C
Storage Temperature Range	$T_{STG}$	-65 to 150	°C
Lead Temperature (Soldering, 10sec)	$T_{LEAD}$	260	°C
Thermal Resistance (Note 2)	$\theta_{JA}$	SOT-89-3   165	°C/W
ESD (Human Body Model)	ESD	3500	V
ESD (Machine Model)	ESD	350	V

Note 1: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

Note 2: Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its operating ratings. The maximum allowable power dissipation is a function of the maximum junction temperature,  $T_{J(max)}$ , the junction-to-ambient thermal resistance,  $\theta_{JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation at any ambient temperature is calculated using:  $P_{D(max)} = (T_{J(max)} - T_A) / \theta_{JA}$ . Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown.

**Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
Input Voltage	$V_{IN}$		12	V
Operating Junction Temperature Range	$T_J$	-40	125	°C

**600mA LOW DROPOUT LINEAR REGULATOR****AP2316****Electrical Characteristics**Operating Conditions:  $V_{IN} \leq 10V$ ,  $T_J = 25^\circ C$ , unless otherwise specified. ( $P \leq$  maximum power dissipation)Limits appearing in **Boldface** type apply over the entire junction temperature range for operation,  $-40^\circ C$  to  $125^\circ C$ 

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Output Voltage	$V_{OUT}$	AP2316-2.5 $I_{OUT} = 10mA$ , $V_{IN} = 4.5V$ , $T_J = 25^\circ C$ $10mA \leq I_{OUT} \leq 600mA$ , $3.9V \leq V_{IN} \leq 10V$	2.475 <b>2.450</b>	2.5 2.5	2.525 <b>2.550</b>	V
		AP2316-3.3 $I_{OUT} = 10mA$ , $V_{IN} = 5.0V$ , $T_J = 25^\circ C$ $10mA \leq I_{OUT} \leq 600mA$ , $4.75V \leq V_{IN} \leq 10V$	3.267 <b>3.235</b>	3.3 3.3	3.333 <b>3.365</b>	V
Line Regulation	$\Delta V_{OUT}$	AP2316-2.5 $I_{OUT} = 10mA$ , $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	<b>6</b>	mV
		AP2316-3.3 $I_{OUT} = 10mA$ , $1.5V \leq V_{IN} - V_{OUT} \leq 10V$		1	<b>6</b>	mV
Load Regulation	$\Delta V_{OUT}$	AP2316-2.5 $(V_{IN} - V_{OUT}) = 2V$ , $10mA \leq I_{OUT} \leq 600mA$		1	<b>10</b>	mV
		AP2316-3.3 $(V_{IN} - V_{OUT}) = 2V$ , $10mA \leq I_{OUT} \leq 600mA$		1	<b>10</b>	mV
Dropout Voltage	$V_{DROP}$	$\Delta V_{OUT} = 1\%$ , $I_{OUT} = 0.6A$		1.1	<b>1.3</b>	V
Current Limit	$I_{LIMIT}$	$(V_{IN} - V_{OUT}) = 2V$	0.75	0.9		A
Quiescent Current	$I_Q$	$V_{IN} = V_{OUT} + 1.25V$			<b>5</b>	mA
Ripple Rejection	PSRR	$f = 120Hz$ , $C_{OUT} = 22\mu F$ $(V_{IN} - V_{OUT}) = 3V$ , $I_{OUT} = 300mA$	<b>60</b>	75		dB
Temperature Stability				<b>0.5</b>		%
Long-Term Stability		$T_A = 125^\circ C$ , 1000hrs.		0.3		%
RMS Output Noise (% of $V_{OUT}$ )		$T_A = 25^\circ C$ , $10Hz \leq f \leq 10KHz$		0.003		%
Thermal Shutdown		Junction Temperature		150		$^\circ C$
Thermal Shutdown Hysteresis				25		$^\circ C$



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**Typical Performance Characteristics**

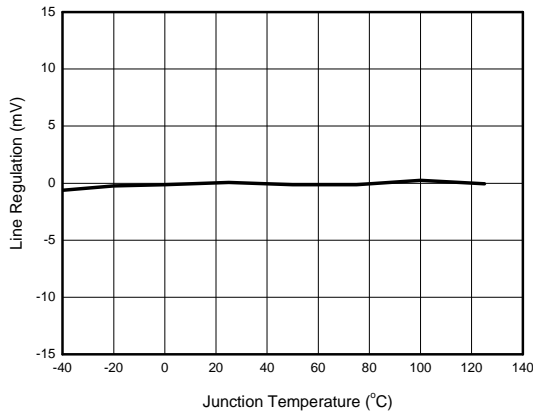


Figure 4. Line Regulation vs. Junction Temperature

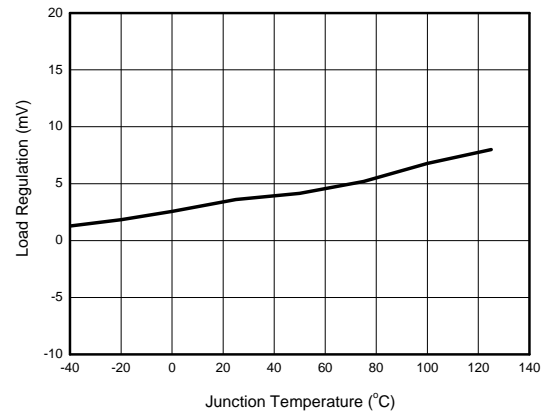


Figure 5. Load Regulation vs. Junction Temperature

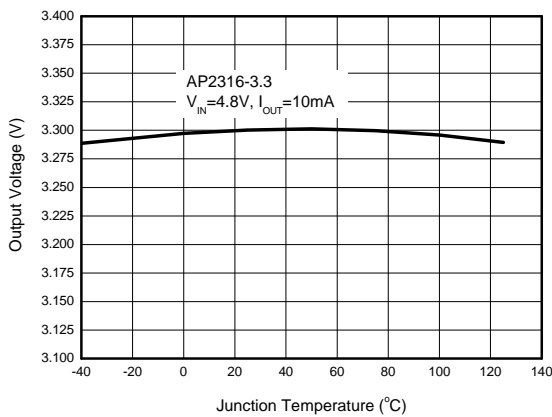


Figure 6. Output Voltage vs. Junction Temperature

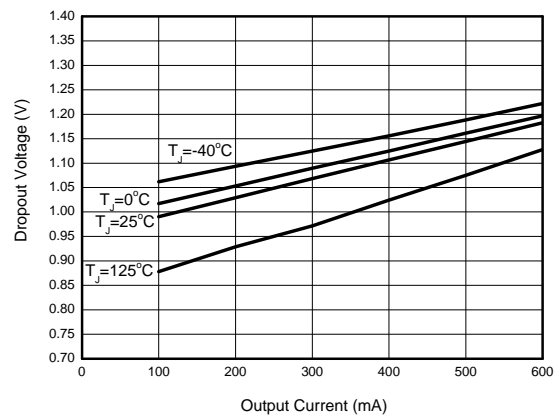


Figure 7. Dropout Voltage vs. Output Current



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**Typical Performance Characteristics (Continued)**

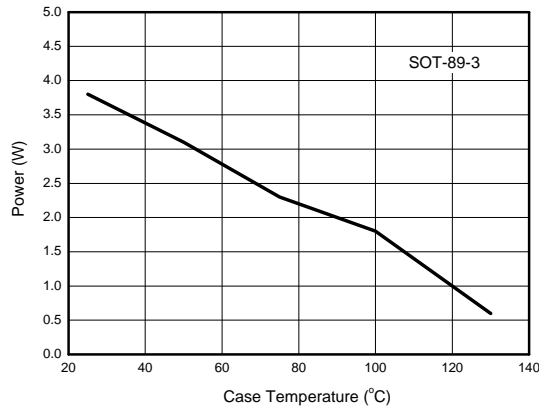


Figure 8. Maximum Power Dissipation

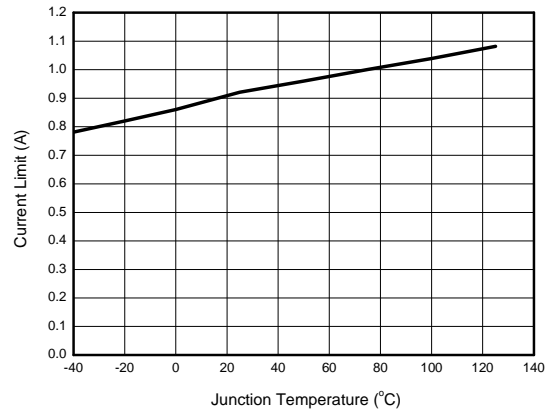


Figure 9. Current Limit vs. Junction Temperature

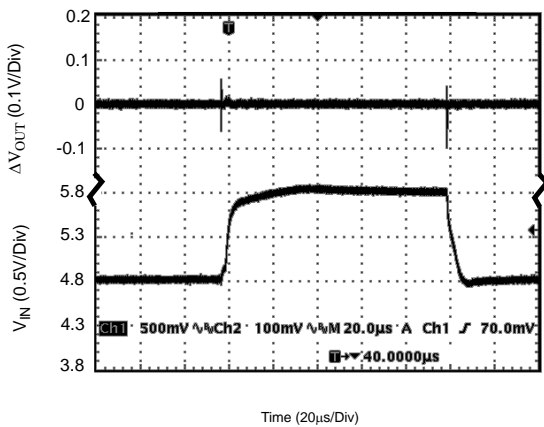


Figure 10. Line Transient Response  
(Conditions:  $V_{IN}=4.8$  to  $5.8V$ ,  $V_{OUT}=3.33V$ ,  $I_{OUT}=0.1A$ ,  
 $C_{IN}=1\mu F$ ,  $C_{OUT}=10\mu F$ )

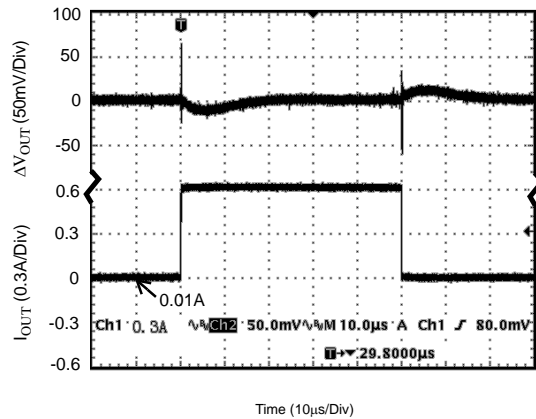


Figure 11. Load Transient Response  
(Conditions:  $V_{IN}=4.8V$ ,  $V_{OUT}=3.33V$ ,  $I_{OUT}=0.01$  to  $0.6A$ ,  
 $C_{IN}=C_{OUT}=10\mu F$ )





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**Typical Performance Characteristics (Continued)**

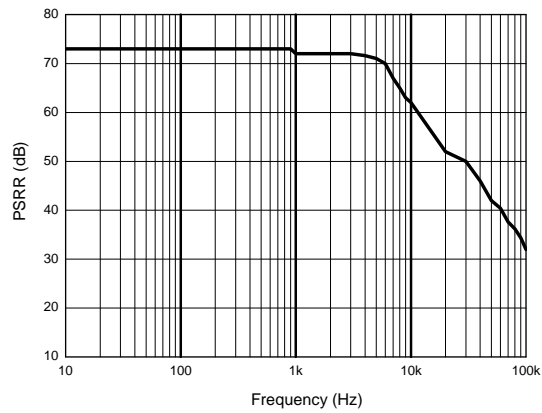


Figure 12. PSRR vs. Frequency



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**Typical Application**

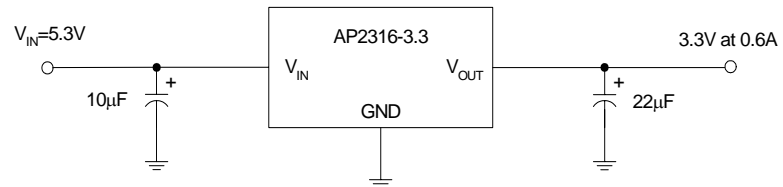


Figure 13. Typical Application of AP2316



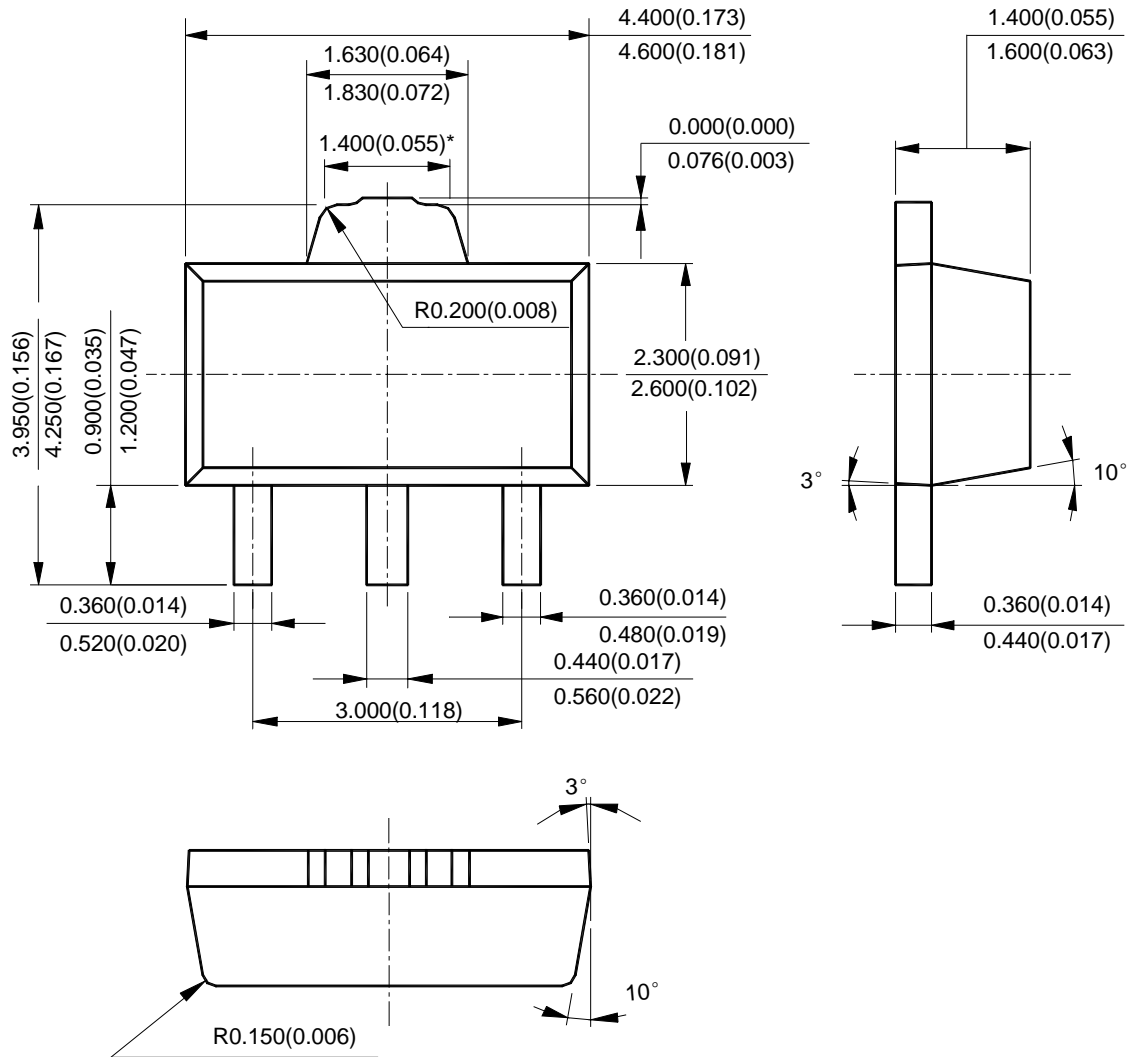
**600mA LOW DROPOUT LINEAR REGULATOR**

**AP2316**

**Mechanical Dimensions**

**SOT-89-3**

**Unit: mm(inch)**





BCD Semiconductor Manufacturing Limited

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#### MAIN SITE

**BCD Semiconductor Manufacturing Limited**  
- Wafer Fab  
Shanghai SIM-BCD Semiconductor Manufacturing Limited  
800, Yi Shan Road, Shanghai 200233, China  
Tel: +86-21-6485 1491, Fax: +86-21-5450 0008

**BCD Semiconductor Manufacturing Limited**  
- IC Design Group  
Advanced Analog Circuits (Shanghai) Corporation  
8F, Zone B, 900, Yi Shan Road, Shanghai 200233, China  
Tel: +86-21-6495 9539, Fax: +86-21-6485 9673

#### REGIONAL SALES OFFICE

**Shenzhen Office**  
Shanghai SIM-BCD Semiconductor Manufacturing Co., Ltd. Shenzhen Office  
Advanced Analog Circuits (Shanghai) Corporation Shenzhen Office  
Room E, 5F, Noble Center, No.1006, 3rd Fuzhong Road, Futian District, Shenzhen 518026, China  
Tel: +86-755-8826 7951  
Fax: +86-755-8826 7865

**Taiwan Office**  
BCD Semiconductor (Taiwan) Company Limited  
4F, 298-1, Rui Guang Road, Nei-Hu District, Taipei, Taiwan  
Tel: +886-2-2656 2808  
Fax: +886-2-2656 2806

**USA Office**  
BCD Semiconductor Corporation  
30920 Huntwood Ave. Hayward, CA 94544, U.S.A  
Tel : +1-510-324-2988  
Fax: +1-510-324-2788